





S1AB THRU S1MB 1.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER



Features

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop
- Low Power Loss
- Built-in Strain Relief
- Plastic Case Material has UL Flammability Classification Rating 94V-0
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- · Case: SMB molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: AnyWeight: 0.09 grams

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Type Number	Symbol	S1AB	S1BB	S1DB	S1GB	S1JB	S1KB	S1MB	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	٧
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Average Rectified Output Current @T _L = 100°C	lo				1.0				Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	30			А				
Forward Voltage @ I _F = 1.0 A	V _F				1.10				V
Peak Reverse Current @T _A = 25°C At Rated DC Blocking Voltage @T _A = 125°C	I _{RM}				5.0 200				μA
Reverse Recovery Time(Note1)	t _{rr}				2.5				μS
Typical Junction Capacitance(Note2)	CJ				15				pF
Typical Thermal Resistance Junction to Lead (Note 3)	R _{θJL}				30				°C/W
Operating and Storage Temperature Range	T _J ,T _{STG}			-65	to +175				°C

Note: 1. Reverse recovery condition IF=0.5A, IR=1.0A, Irr=0.25A

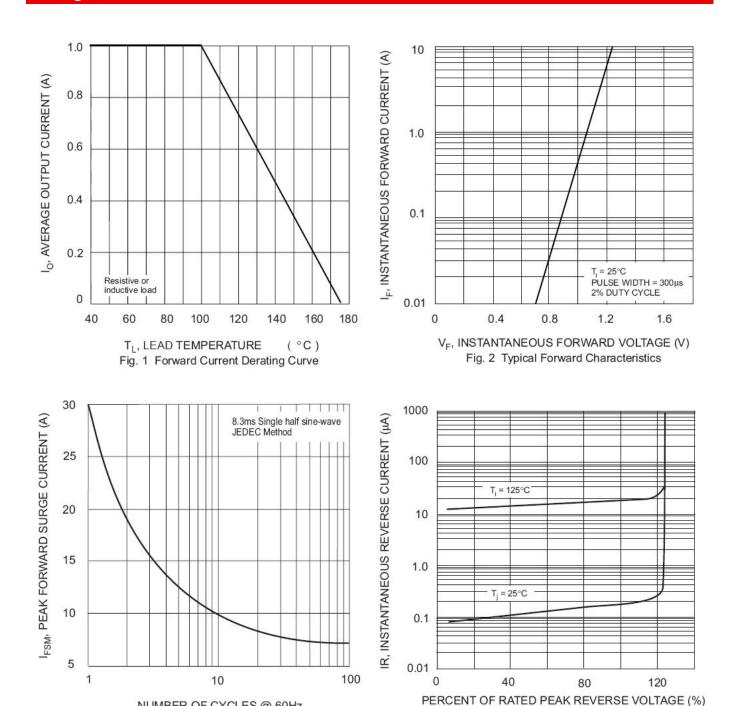
- 2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
- 3. Mounted on P.C.B.with 8.0mm² land areas.
 - China Germany Korea Singapore United States •
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Ratings and Characteristics Curves



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Fig. 4 Typical Reverse Characteristics

NUMBER OF CYCLES @ 60Hz

Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

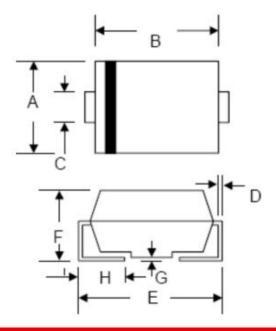
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Mechanical Dimensions SMB



SYMBOL	Millir	meters	Inches		
STIVIBUL	Min.	Max.	Min.	Max.	
А	3.30	3.94	0.130	0.155	
В	4.06	4.70	0.160	0.185	
С	1.80	2.20	0.071	0.087	
D	0.152	0.305	0.006	0.012	
Е	4.80	5.59	0.189	0.220	
F	2.10	2.60	0.083	0.102	
G	0.051	0.203	0.002	0.008	
Н	0.76	1.52	0.030	0.060	

Ordering Information

Device		Package	Shipping			
	S1AB-S1MB	SMB(Pb-Free)	3000pcs / reel			

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

 S1AB
 = Type Number

 YY
 = Year

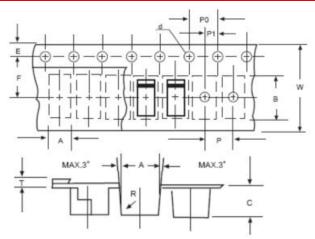
 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Carrier Tape Specification SMB



SYMBOL	Millimeters			
STWIBOL	Min.	Max.		
Α	3.99	4.19		
В	5.72	5.92		
С	3.23	3.43		
d	1.40	1.60		
E	1.40	1.60		
F	5.60	5.70		
Р	7.90	8.10		
P0	3.90	4.10		
P1	1.90	2.10		
T	-	0.60		
W	11.80	12.20		

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